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Atmospheric Neutron Radiation Response of III-V Binary Compound Semiconductors

Jean-Luc Autran, Senior Member, IEEE, Daniela Munteanu, Member, IEEE

Abstract—This work examines the radiation response of III-V binary compound semiconductors subjected to high energy atmospheric neutrons. Production of neutron-induced secondary products and implications for single event effects are carefully analyzed and discussed.

Index Terms—atmospheric neutrons, binary compound semiconductors, III-V materials, neutron cross section, elastic scattering, noneleastic interactions, nuclear data library, Geant4, numerical simulation.

I. INTRODUCTION

Beyond optoelectronics, high-frequency or integrated power applications, III-V semiconductor materials are becoming attractive materials for advanced CMOS nanoelectronics; they are currently extensively investigated in the perspective of silicon replacement for both n-channel and p-channel materials in CMOS, due to higher carrier mobilities for both electrons (GaAs, InAs, InGaAs, InP) and holes (GaSb, InGaSb) with respect to Si and compatibility with high-k dielectric-based gate stacks [1-3]. A recent work demonstrated that nanowire n-type (InAs) and p-type (GaSb) transistors can be co-processed and co-integrated in a viable alternative to current CMOS silicon technology, offering increased drive-currents up to 1800 μA/μm for the n-MOS device [4].

From a radiation effect point-of-view, total ionizing dose (TID), heavy ion and laser responses of III-V MOS transistors in modern architectures have been recently studied [5-7]. III-V materials and related devices have been also extensively investigated from the perspective of the creation mechanisms of single event effects [8-10] but relatively little work concerns their response to atmospheric neutrons. The aim of this work is precisely to examine the radiation response of III-V binary compound semiconductors subjected to high energy atmospheric neutrons. The paper is organized as follows.

Section II presents the different compound materials studied and summarizes their main properties. Section III details the direct and Geant4 calculation of the atmospheric neutron reaction rate in a layer of material; section IV presents a complete analysis of neutron-induced secondaries produced in these III-V materials using Geant4. Finally, implications for single event effects are discussed in the conclusion of this work.

II. MATERIAL PROPERTIES AND NUCLEAR DATA LIBRARIES

In this work, the atmospheric neutron response of eight III-V binary compound materials have been studied: GaAs, AlAs, InP, InAs, GaSb, InSb, GaN and GaP (GaAs and GaN materials have been recently explored in [11]). Table I summarizes the main experimental values for these materials in terms of bandgap, density, and electron-hole pair creation energy. This last data is missing in literature for GaSb and InSb; we used values deduced from the Klein’s model [12] linking energy bandgap and energy for e-h pair creation in semiconductor materials (Fig. 1).

![Energy for e-h pair creation as a function of the bandgap energy for the III-V binary compound materials studied in this work.](image)

Table I. Main properties of the III-V binary compounds studied in this work.

<table>
<thead>
<tr>
<th>III-V binary compound</th>
<th>Bandgap @ 300K (eV)</th>
<th>Number of atoms per cm³ (×10²²)</th>
<th>Density (g/cm³)</th>
<th>Electron-hole pair creation energy (eV)</th>
</tr>
</thead>
<tbody>
<tr>
<td>GaAs</td>
<td>1.42</td>
<td>4.42</td>
<td>5.32</td>
<td>4.8</td>
</tr>
<tr>
<td>AlAs</td>
<td>2.16</td>
<td>4.42</td>
<td>3.76</td>
<td>6.8</td>
</tr>
<tr>
<td>InP</td>
<td>1.34</td>
<td>3.96</td>
<td>4.81</td>
<td>4.5</td>
</tr>
<tr>
<td>InAs</td>
<td>0.36</td>
<td>3.59</td>
<td>5.67</td>
<td>1.8</td>
</tr>
<tr>
<td>GaSb</td>
<td>0.73</td>
<td>3.53</td>
<td>5.61</td>
<td>-</td>
</tr>
<tr>
<td>InSb</td>
<td>0.17</td>
<td>2.94</td>
<td>5.78</td>
<td>-</td>
</tr>
<tr>
<td>GaN</td>
<td>3.39</td>
<td>8.90</td>
<td>6.15</td>
<td>8.9</td>
</tr>
<tr>
<td>GaP</td>
<td>2.26</td>
<td>4.94</td>
<td>4.138</td>
<td>6.8</td>
</tr>
</tbody>
</table>

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TABLE II. NATURAL ABUNDANCE OF NUCLIDES RELATED TO III-V BINARY COMPOUNDS MATERIALS STUDIED IN THIS WORK AND AVAILABILITY OF CROSS SECTION IN EDNFB-VII.1 AND TENDL-2017 NUCLEAR DATA LIBRARIES.

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Atomic number</th>
<th>Nuclide</th>
<th>Natural abundance</th>
<th>ENDFB-VII.1 (20 MeV)</th>
<th>TENDL-2017 (200 MeV)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Al</td>
<td>13</td>
<td>13-Al-27</td>
<td>100.00%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Ga</td>
<td>31</td>
<td>31-Ga-69</td>
<td>60.10%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td></td>
<td></td>
<td>31-Ga-71</td>
<td>39.90%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>In</td>
<td>49</td>
<td>49-In-115</td>
<td>95.70%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td></td>
<td></td>
<td>49-In-113</td>
<td>4.30%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>N</td>
<td>7</td>
<td>7-N-14</td>
<td>99.60%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td></td>
<td></td>
<td>7-N-15</td>
<td>0.40%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>P</td>
<td>15</td>
<td>15-P-31</td>
<td>100.00%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>As</td>
<td>33</td>
<td>33-As-75</td>
<td>100.00%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Sb</td>
<td>51</td>
<td>51-Sb-121</td>
<td>57.40%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td></td>
<td></td>
<td>51-Sb-123</td>
<td>42.60%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Si</td>
<td>14</td>
<td>14-Si-29</td>
<td>4.70%</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td></td>
<td></td>
<td>14-Si-30</td>
<td>3.10%</td>
<td>✓</td>
<td>✓</td>
</tr>
</tbody>
</table>

*Extended to 120 MeV

The III-V binary compounds studied in the following are made from seven chemical elements from columns III (Al, Ga, In) and V (N, P, As, Sb) of the periodic table. We voluntarily excluded boron-based compounds (BN, BP, BAs, BSb) from this study, due to the thermal neutron sensitivity of these materials (if not selective in isotopes) induced by the presence of $^{10}$B. Table II indicates the isotope composition of these elements and their natural abundance. The study of atmospheric neutron interactions with the compounds of Table I requires: i) the availability of neutron cross-sections for all nuclides listed in Table II and ii) if possible, an extended energy range above 1 MeV, due to the nature of the atmospheric neutron spectrum [13]. Even if the US standard evaluated nuclear data library ENDF/B (ENDFB-VII.1) [14] responds well to the first point (in particular for In and Sb that are not included in all nuclear data libraries), however, the upper energy limit is only 20 MeV for Ga, In, Sb and As. After checking of several nuclear data libraries, we choose the new release of the TENDL library (TENDL-2017) [15] that offers availability of all neutron cross-sections up to 200 MeV. Fig. 2 shows the total cross sections for the most abundant nuclides for the seven elements and also for 14-Si-28 for comparison. These data are used in the next section to evaluate the neutron reaction rate in a layer of the different compound materials.

III. NEUTRON REACTION RATES IN A LAYER OF MATERIAL

The susceptibility of the studied materials to atmospheric neutron has been roughly evaluated by a direct calculation of the reaction rate in a target representative of a microelectronic circuit, following a method introduced by Wrobel et al [16].

According to [16], we first calculated the number of nuclear reactions $R_n$ in a material layer with an area of $S=1 \text{ mm}^2$, a thickness of $e=1 \mu \text{m}$ and an atomic density equal to that of silicon (N=5 x10$^{22}$ at./cm$^3$). $R_n$ is simply given by:

$$ R_n = N e \int_{E_{\text{min}}}^{E_{\text{max}}} \sigma(E) \frac{d\phi}{dE} dE $$

(1)

where $\sigma(E)$ is the neutron cross section of the considered element constituting the material, $d\phi/dE$ is the differential neutron flux (measured by Goldhagen and modeled by Gordon et al. [13]), $E_{\text{min}}$ and $E_{\text{max}}$ are the limits of the energy domain considered (in the following, $E_{\text{min}} = 1 \text{ MeV}$ and $E_{\text{max}} = 200 \text{ MeV}$).

Fig. 3 shows the results of our calculations using Eq. (1) applied to “materials” constituted by a single element of Table II with an isotope composition mimicking the natural abundance. In order to compare with Wrobel’s data, nuclear rates are expressed for a duration of $10^9$ h and for a neutron flux corresponding to 12 km altitude. Our results shown in Fig. 3 are in very good agreement with Wrobel’s data. For each element, we give in addition the number of elastic and nonelastic events directly evaluated from TENDL-2017 (MF=3, MT=2 for elastic cross section).

![Fig. 2. High energy (> 1 MeV) neutron cross sections for the main nuclides related to the III-V materials studied. Data from the TENDL-2017 nuclear data library.](image)

![Fig. 3. Calculated number of nuclear interactions in 10$^9$ h induced by high energy (>1 MeV) atmospheric neutrons in a layer of material of 1 mm$^2$. Data are compared to previous results published in [16].](image)
From data of Fig. 3, the reaction rates for all the III-V materials of Table I can be deduced, taken into account the exact number of atoms per cm$^3$ and the binary nature of the compounds. In order to compare with our previously published results on Si [17], Ge and SiC [11], we change in the following the normalization factors introduced for the expression of the nuclear rates, choosing now: S = 1 cm$^2$, e = 20 µm, duration of 5x10$^6$ h and neutron flux at sea level. With respect to Wrobel’s conditions previously used in Fig. 3, these differences result in new reaction rates equal to Wrobel’s ones exactly divided by a numerical factor of 50.

Fig. 4 shows the results of these calculations for nuclear interaction rates evaluated from ENDFB-VII.1 and TENDL-2017 nuclear data libraries and from Monte Carlo simulations using Geant4 (8 separate runs for each compound as the target material). Details for Geant4 simulations can be found in Ref. [11]. With respect to Fig. 3, the neutron reaction rates considering the exact number of atoms per volume unit leads to significantly narrow the range of values: almost all materials, GaN excepted, exhibit similar global reaction rates, between 13,000 and 18,000 for Geant4 simulations. Between all materials, GaSb and InSb show the number of interaction events the closest from the one of Si. GaN4 values are logically found greater to those derived from ENDFB-VII.1 (limited to 20 MeV in energy) but slightly lower to those obtained with TENDL-2017 (statistically considering, in this case, more events at high energies). In the next section, Geant4 databases are analyzed in order to examine in detail the production of secondaries for the different binary compounds.

IV. DETAILED ANALYSIS OF SECONDARY PRODUCTS

For standardization purposes [11,17], we eliminated in the following all secondary particles not able to deposit an electrical charge in the target material above a certain threshold quantity, fixed in previous studies equal to 1.8 fC [17]. This database post-treatment eliminates from the following analysis the less energetic recoils and all $\gamma$ photons, $\pi^0$, rare $\pi^-$ and $\pi^+$, e$^+$, e$^-$ and $\eta$ particles, not able to induce a single event transient susceptible to lead to an error in a given circuit. This mechanically decreases the number of elastic events (less energetic events).

Fig. 5 shows the distributions of elastic and nonelastic events for the different III-V compound materials. The number of low energy elastic events, eliminated from the different databases are also indicated.

Fig. 6. Distribution of products resulting from the interactions of atmospheric neutrons with the different III-V binary compound materials obtained from Geant4 simulations. The low energy elastic events eliminated from the different databases are also indicated.
interactions in both categories, elastic and nonelastic, mainly due to the number of atoms per volume unit for this compound semiconductor which is almost double with respect to all other materials (see Table I).

Fig. 6 shows the distribution of all secondaries produced by atmospheric neutron interactions in the different targets of III-V binary compound materials; Fig. 7 gives their energy distribution. Four groups of particles have been defined in Fig. 6: protons, alpha particles, nuclei corresponding to target atoms (named recoils #1 and #2 indexed as a function of increasing Z) and other nuclei. Similar distributions of these particle groups indexed as a function of increasing Z), GaN excepted, with approximately 25% of protons+alphas, 60% of target nuclei and the remaining 15% of other nuclei. For GaN, a higher proportion of protons and alpha particles is observed (40%), due to significant cross sections for $^{14}\text{N}(n,p)^{14}\text{C}$ and $^{14}\text{N}(n,\alpha)^{11}\text{B}$ reactions. Additional results and histograms per product category will be analyzed in the final paper, notably in terms of particle LET, range, angular distribution, shower multiplicities and reaction channels.

V. IMPLICATIONS FOR THE SEEES

Concerning SEEEs, one interesting global metric is the amount of electrical charge indirectly deposited by atmospheric neutrons in the different material targets. Fig. 8 shows this total number of e-h pairs induced by all secondaries for the different III-V compounds with respect to the value obtained for silicon. Three groups of materials can be distinguished in Fig. 8: GaAs, AlAs, InP, GaN and GaP that are finally found very similar to Si in terms of e-h pair generation (relative factor close to 1), InAs and GaSb which exhibit a factor between 1.5 and 2.5 and, finally, InSb characterized by the highest factor, close to 4. This result suggests a susceptibility to atmospheric neutrons at material level more important for InSb, InAs and GaSb than the one observed in the other compounds and in silicon.

This preliminary exploration of III-V binary compound materials should be now completed by the evaluation of the impact of carrier mobilities and lifetimes on the formation of single-event transients in reversely biased junctions to conclude on their level of vulnerability to natural neutron radiation at ground level.

VI. REFERENCES